

# NXH80T120L2Q0PG, NXH80T120L2Q0SG

**ELECTRICAL CHARACTERISTICS** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
<b>HALF BRIDGE IGBT CHARACTERISTICS</b>						
Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 80 \text{ A}, T_J = 25^\circ\text{C}$ $V_{GE} = 15 \text{ V}, I_C = 80 \text{ A}, T_J = 150^\circ\text{C}$	$V_{CE(\text{sat})}$	1.7	2.17 2.20	2.7	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 1.5 \text{ mA}$	$V_{GE(\text{TH})}$	5.0	6.0	6.5	V
Collector-emitter cutoff current	$V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}$	$I_{CES}$	—	—	200	$\mu\text{A}$
Gate leakage current	$V_{GE} = 20 \text{ V}, V_{CE} = 0 \text{ V}$	$I_{GES}$	—	—	1.2	$\mu\text{A}$
Turn-on delay time	$T_j = 25^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$t_{d(\text{on})}$	—	35	—	ns
Rise time		$t_r$	—	28	—	
Turn-off delay time		$t_{d(\text{off})}$	—	280	—	
Fall time		$t_f$	—	28	—	
Turn on switching loss		$E_{\text{on}}$	—	0.670	—	mJ
Turn off switching loss		$E_{\text{off}}$	—	1.3	—	
Turn-on delay time		$t_{d(\text{on})}$	—	80	—	ns
Rise time		$t_r$	—	30	—	
Turn-off delay time		$t_{d(\text{off})}$	—	320	—	
Fall time		$t_f$	—	230	—	
Turn on switching loss		$E_{\text{on}}$	—	0.975	—	mJ
Turn off switching loss		$E_{\text{off}}$	—	3.00	—	
Input capacitance	$V_{CE} = 20 \text{ V}, V_{GE} = 0 \text{ V}, f = 10 \text{ KHz}$	$C_{ies}$	—	19940	—	pF
Output capacitance		$C_{oes}$	—	592	—	
Reverse transfer capacitance		$C_{res}$	—	383	—	
Gate charge total	$V_{CE} = 960 \text{ V}, I_C = 40 \text{ A}, V_{GE} = \pm 15 \text{ V}$	$Q_g$	—	840	—	nC
Thermal Resistance, chip-to-heatsink	Thermal grease thickness $\leq 50 \mu\text{m}$ $\lambda = 1 \text{ W/mK}$	$R_{\theta JH}$		0.65		$^\circ\text{C/W}$

## HALF BRIDGE DIODE CHARACTERISTICS

Forward voltage	$V_{GE} = 0 \text{ V}, I_F = 50 \text{ A}, T_J = 25^\circ\text{C}$ $V_{GE} = 0 \text{ V}, I_F = 50 \text{ A}, T_j = 150^\circ\text{C}$	$V_F$	—	1.81 1.90	2.4	V
Reverse recovery time	$T_j = 25^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$t_{rr}$	—	0.12	—	$\mu\text{s}$
Reverse recovery charge		$Q_{rr}$	—	4.7	—	$\mu\text{C}$
Peak reverse recovery current		$I_{rrm}$	—	135	—	A
Peak rate of fall of recovery current		$di/dt_{\text{max}}$	—	7200	—	$\text{A}/\mu\text{s}$
Reverse recovery energy		$E_{rr}$	—	1.37	—	mJ
Reverse recovery time		$t_{rr}$	—	0.14	—	$\mu\text{s}$
Reverse recovery charge	$T_j = 150^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$Q_{rr}$	—	7.65	—	$\mu\text{C}$
Peak reverse recovery current		$I_{rrm}$	—	138	—	A
Peak rate of fall of recovery current		$di/dt_{\text{max}}$	—	4900	—	$\text{A}/\mu\text{s}$
Reverse recovery energy		$E_{rr}$	—	2.15	—	mJ
Thermal Resistance, chip-to-heatsink	Thermal grease thickness $\leq 50 \mu\text{m}$ $\lambda = 1 \text{ W/mK}$	$R_{\theta JH}$		1.38		$^\circ\text{C/W}$

## NEUTRAL POINT CLAMP IGBT CHARACTERISTICS

Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 30 \text{ A}, T_J = 25^\circ\text{C}$ $V_{GE} = 15 \text{ V}, I_C = 30 \text{ A}, T_J = 150^\circ\text{C}$	$V_{CE(\text{sat})}$	1.1	1.3 1.3	1.6	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 1.2 \text{ mA}$	$V_{GE(\text{TH})}$	5.0	5.7	6.5	V
Collector-emitter cutoff current	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$	$I_{CES}$	—	—	100	$\mu\text{A}$
Gate leakage current	$V_{GE} = 20 \text{ V}, V_{CE} = 0 \text{ V}$	$I_{GES}$	—	—	0.60	$\mu\text{A}$

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Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
<b>NEUTRAL POINT CLAMP IGBT CHARACTERISTICS</b>						
Turn-on delay time	$T_j = 25^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$t_{d(on)}$	—	46	—	ns
Rise time		$t_r$	—	16	—	
Turn-off delay time		$t_{d(off)}$	—	125	—	
Fall time		$t_f$	—	60	—	mJ
Turn on switching loss		$E_{on}$	—	0.668	—	
Turn off switching loss		$E_{off}$	—	0.76	—	
Turn-on delay time	$T_j = 150^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$t_{d(on)}$	—	48	—	ns
Rise time		$t_r$	—	22	—	
Turn-off delay time		$t_{d(off)}$	—	200	—	
Fall time		$t_f$	—	134	—	mJ
Turn on switching loss		$E_{on}$	—	1.1	—	
Turn off switching loss		$E_{off}$	—	2.5	—	
Input capacitance	$V_{CE} = 20 \text{ V}, V_{GE} = 0 \text{ V}, f = 10 \text{ KHz}$	$C_{ies}$	—	9900	—	pF
Output capacitance		$C_{oes}$	—	270	—	
Reverse transfer capacitance		$C_{res}$	—	270	—	
Gate charge total	$V_{CE} = 480 \text{ V}, I_C = 75 \text{ A}, V_{GE} = \pm 15 \text{ V}$	$Q_g$	—	390	—	nC
Thermal Resistance, chip-to-heatsink	Thermal grease thickness $\leq 50 \mu\text{m}$ $\lambda = 1 \text{ W/mK}$	$R_{\theta JH}$		1.35		$^\circ\text{C/W}$

## NEUTRAL POINT CLAMP DIODE CHARACTERISTICS

Forward voltage	$V_{GE} = 0 \text{ V}, I_F = 60 \text{ A}, T_j = 25^\circ\text{C}$ $V_{GE} = 0 \text{ V}, I_F = 60 \text{ A}, T_j = 150^\circ\text{C}$	$V_F$	—	1.7	2.0	V
Reverse recovery time	$T_j = 25^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$t_{rr}$	—	0.04	—	$\mu\text{s}$
Reverse recovery charge		$Q_{rr}$	—	1.1	—	$\mu\text{C}$
Peak reverse recovery current		$I_{rrm}$	—	65	—	A
Peak rate of fall of recovery current		$di/dt_{max}$	—	6600	—	$\text{A}/\mu\text{s}$
Reverse recovery energy		$E_{rr}$	—	0.384	—	mJ
Reverse recovery time		$t_{rr}$	—	0.1	—	$\mu\text{s}$
Reverse recovery charge	$T_j = 150^\circ\text{C}$ $V_{CE} = 350 \text{ V}, I_C = 56 \text{ A}$ $V_{GE} = \pm 15 \text{ V}, R_G = 4 \Omega$	$Q_{rr}$	—	3.3	—	$\mu\text{C}$
Peak reverse recovery current		$I_{rrm}$	—	68	—	A
Peak rate of fall of recovery current		$di/dt_{max}$	—	1733	—	$\text{A}/\mu\text{s}$
Reverse recovery energy		$E_{rr}$	—	0.74	—	mJ
Thermal Resistance, chip-to-heatsink	Thermal grease thickness $\leq 50 \mu\text{m}$ $\lambda = 1 \text{ W/mK}$	$R_{\theta JH}$		1.86		$^\circ\text{C/W}$

## THERMISTOR CHARACTERISTICS

Normal resistance		R		22		$\text{k}\Omega$
Nominal resistance	$T = 100^\circ\text{C}$	R		1468		$\Omega$
Deviation of R25		$\Delta R/R$	-5	5		%
Power dissipation		$P_D$		200		mW
Power dissipation constant				2		$\text{mW/K}$
B-value	B(25/50), tol $\pm 3\%$				3950	K
B-value	B(25/100), tol $\pm 3\%$				3998	K
NTC reference					B	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.